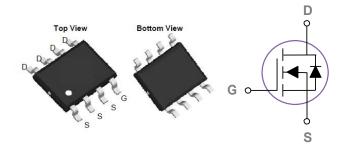


30V N-Channel MOSFET

General Description

KSP4468 The series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible onresistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

SOP-8 Pin Configuration



Product Summary

V _{DS} (V)	$\mathbf{R}_{DS(on)}$ (m Ω)	I _D (A)
30	9 at VGS = 10 V	13
	12 at V _{GS} = 4.5 V	10.2

Features

High density cell design for ultra low Rdson

• Fully characterized avalanche voltage and current

Applications

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

Absolute Maximum Ratings Tc=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	30	V
Vgs	Gate-Source Voltage	±20	V
	Drain Current – Continuous (Tc=25°C)	13	А
lD	Drain Current – Continuous (Tc=100°C)	7	A
Ідм	Drain Current – Pulsed ¹	45	А
<u>م</u>	Power Dissipation (Tc=25℃)	2.5	W
Po	Power Dissipation (T _c =100°C)	0.06	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
R _{0JA}	Thermal Resistance Junction to ambient		57	°C/W
Rejc	Thermal Resistance Junction to Case		4.5	°C/W

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30V N-Channel MOSFET

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
IDSS	Drain-Source Leakage Current	V _{DS} =25V , V _{GS} =0V , T _J =25℃			1	uA
		V _{DS} =25V , V _{GS} =0V , TJ=125℃			25	uA
lgss	Gate-Source Leakage Current	V_{GS} = $\pm 20V$, V_{DS} = $0V$			±100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =10A		9	12	mΩ
TOS(ON)		V _{GS} =4.5V , I _D =8A		12	16.5	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.0	1.8	2.5	V
gfs	Forward Transconductance	V _{DS} =10V , I _S =10A		15		S

Dynamic and switching Characteristics

Qg	Total Gate Charge		 15	
Qgs	Gate-Source Charge	V_{DS} =15V , V_{GS} =5V , I_{D} =10A	 5.9	 nC
Q_{gd}	Gate-Drain Charge		 4.2	
T _{d(on)}	Turn-On Delay Time		 33	
Tr	Rise Time	VDS=25V,ID=1A	 21	 ns
$T_{d(off)}$	Turn-Off Delay Time	Vgs=10V,Rg=6Ω	 106	 115
Tf	Fall Time		 87	
Ciss	Input Capacitance		 675	
Coss	Output Capacitance	V_{DS} =15V , V_{GS} =0V , F=1MHz	 78	 pF
C _{rss}	Reverse Transfer Capacitance		 52	

Drain-Source Diode Characteristics and Maximum Ratings

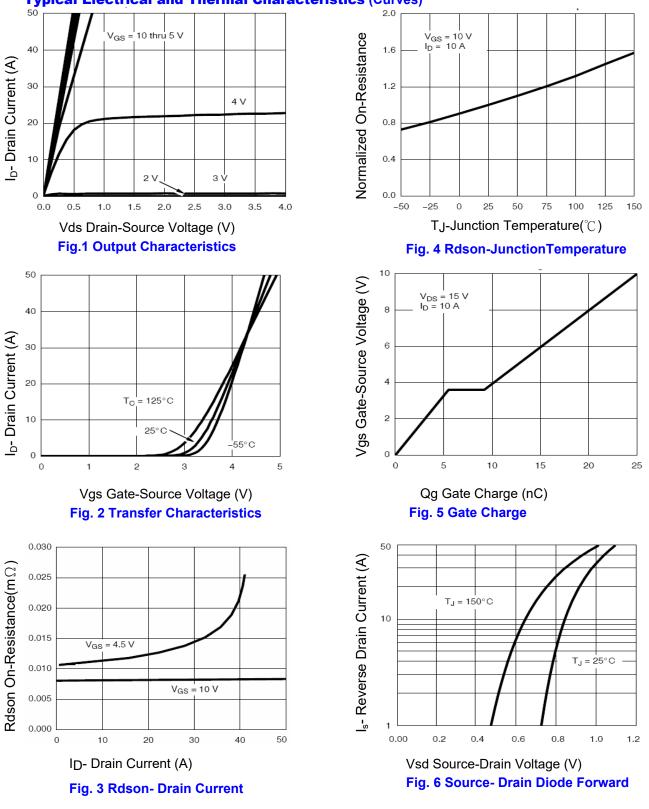
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current	$V_G=V_D=0V$, Force Current			13	А
lsм	Pulsed Source Current				30	А
V _{SD}	Diode Forward Voltage	V _{GS} =0V , Is=1A , Tյ=25℃			1.2	V

Note :

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production



30V N-Channel MOSFET



Typical Electrical and Thermal Characteristics (Curves)

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30V N-Channel MOSFET

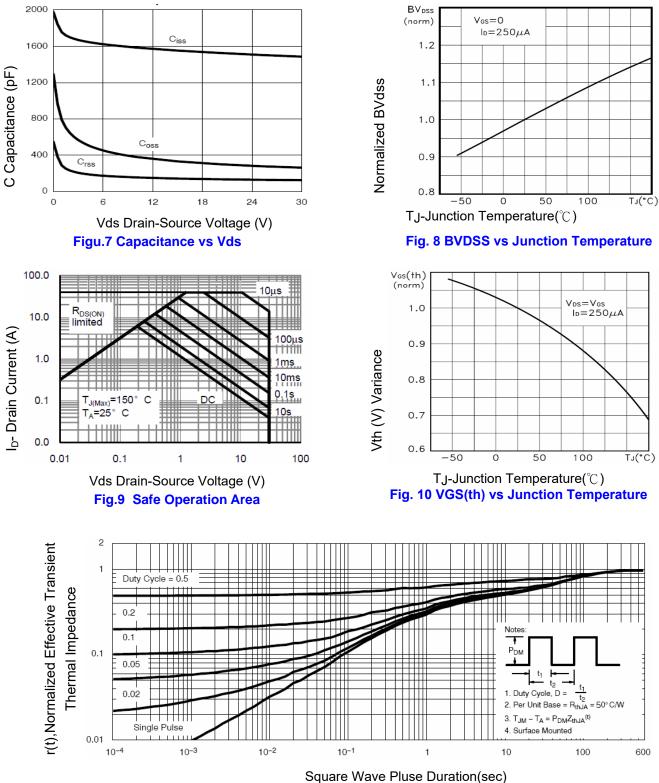


Fig.11 Normalized Maximum Transient Thermal Impedance



30V N-Channel MOSFET

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